

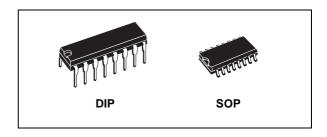


DIFFERENT 4-CHANNEL ANALOG MULTIPLEXER

- LOW "ON" RESISTANCE : 125Ω (Typ.) OVER 15V p.p SIGNAL-INPUT RANGE FOR V_{DD} - V_{EE} = 15V
- HIGH "OFF" RESISTANCE : CHANNEL LEAKAGE ± 100pA (Typ.) at V_{DD} V_{EE} = 18V
- BINARY ADDRESS DECODING ON CHIP
- HIGH DEGREE OF LINEARITY : < 0.5% DISTORTION TYP. at f_{IS} = 1KHz, V_{IS} = 5 V_{pp} , V_{DD} V_{SS} ≥ 10V, RL = 10K Ω
- VERY LOW QUIESCENT POWER DISSIPATION UNDER ALL DIGITAL CONTROL INPUT AND SUPPLY CONDITIONS: 0.2 µW (Typ.) at V_{DD} - V_{SS} = V_{DD} - V_{EE} =10V
- MATCHED SWITCH CHARACTERISTICS : $R_{ON} = 5Ω$ (Typ.) FOR $V_{DD} V_{EE} = 15V$
- WIDE RANGE OF DIGITAL AND ANALOG SIGNAL LEVELS: DIGITAL 3 to 20, ANALOG TO 20V p.p.
- QUIESCENT CURRENT SPECIF. UP TO 20V
- 5V, 10V AND 15V PARAMETRIC RATINGS
- INPUT LEAKAGE CURRENT I_I = 100nA (MAX) AT V_{DD} = 18V T_A = 25°C
- 100% TESTED FOR QUIESCENT CURRENT
- MEETS ALL REQUIREMENTS OF JEDEC JESD13B " STANDARD SPECIFICATIONS FOR DESCRIPTION OF B SERIES CMOS DEVICES"

DESCRIPTION

The HCF4052B is a monolithic integrated circuit fabricated in Metal Oxide Semiconductor



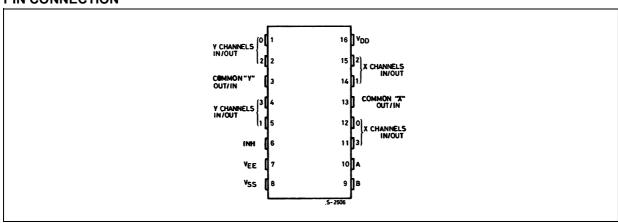
ORDER CODES

| PACKAGE | TUBE | T&R |
|---------|------------|---------------|
| DIP | HCF4052BEY | |
| SOP | HCF4052BM1 | HCF4052M013TR |

technology available in DIP and SOP packages. The HCF4052B analog multiplexer/demultiplexer is a digitally controlled analog switch having low ON impedance and very low OFF leakage current. This multiplexer circuit dissipate extremely low quiescent power over the full $\rm V_{DD}$ - $\rm V_{SS}$ and $\rm V_{DD}$ - $\rm V_{EE}$ supply voltage range, independent of the logic state of the control signals.

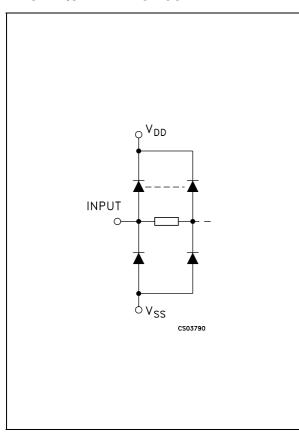
When a logic "1" is present at the inhibit input terminal all channel are off. This device is a differential 4-channel multiplexer having two binary control inputs, A and B and an inhibit input. The two binary input signals selects 1 of 4 pairs of channels to be turned on and connect the analog inputs to the outputs.

PIN CONNECTION



October 2002 1/11

INPUT EQUIVALENT CIRCUIT



PIN DESCRIPTION

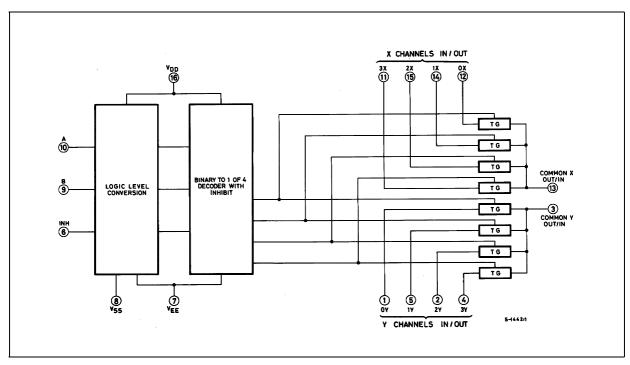
| PIN No | SYMBOL | NAME AND FUNCTION |
|-------------------|-------------------------------|-------------------------|
| 10, 9 | A, B | Binary Control Inputs |
| 6 | INH | Inhibit Inputs |
| 12, 14, 15, 11 | 0X to 3X CHANNEL IN/OUT | X channels Input/Output |
| 1, 5, 2, 4 | 0Y to 3Y CHANNEL IN/OUT | Y channels Input/Output |
| 3 | COM Y OUT/ IN | Y Common Output/Input |
| 13 | COM X OUT/ IN | X Common Output/Input |
| 7 | V _{EE} | Supply Voltage |
| 8 | V_{SS} | Negative Supply Voltage |
| 16 | V_{DD} | Positive Supply Voltage |

TRUTH TABLE

| INHIBIT | В | Α | |
|---------|---|---|--------|
| 0 | 0 | 0 | 0x, 0y |
| 0 | 0 | 1 | 1x, 1y |
| 0 | 1 | 0 | 2x, 2y |
| 0 | 1 | 1 | 3x, 3y |
| 1 | Х | Х | NONE |

X : Don't Care

FUNCTIONAL DIAGRAM



ABSOLUTE MAXIMUM RATINGS

| Symbol | Parameter | Value | Unit |
|------------------|---|-------------------------------|------|
| V_{DD} | Supply Voltage | -0.5 to +22 | V |
| VI | DC Input Voltage | -0.5 to V _{DD} + 0.5 | V |
| l _l | DC Input Current | ± 10 | mA |
| P _D | Power Dissipation per Package | 500 (*) | mW |
| | Power Dissipation per Output Transistor | 100 | mW |
| T _{op} | Operating Temperature | -55 to +125 | °C |
| T _{stg} | Storage Temperature | -65 to +150 | °C |

Absolute Maximum Ratings are those values beyond which damage to the device may occur. Functional operation under these conditions is not implied.

All voltage values are referred to V_{SS} pin voltage.

(*) 500mW at 65 °C; derate to 300mW by 10mW/°C from 65°C to 85°C

RECOMMENDED OPERATING CONDITIONS

| Symbol | Parameter | Value | Unit |
|-----------------|-----------------------|----------------------|------|
| V _{DD} | Supply Voltage | 3 to 20 | V |
| V _I | Input Voltage | 0 to V _{DD} | V |
| T _{op} | Operating Temperature | -55 to 125 | °C |

DC SPECIFICATIONS

| | | Test Condition | | | | Value | | | | | | | |
|----------------------------------|---|--|-------------------|-----------------|-----------------|-------|-----------------------|------|-------------|------|--------------|------|------|
| Symbol | Parameter | V _{IS} | V _{EE} | V _{SS} | V _{DD} | Т | T _A = 25°C | | -40 to 85°C | | -55 to 125°C | | Unit |
| | | (V) | (V) | (V) | (V) | Min. | Тур. | Max. | Min. | Max. | Min. | Max. | |
| ΙL | Quiescent Device | | | | 5 | | 0.04 | 5 | | 150 | | 150 | |
| | Current (all | | | | 10 | | 0.04 | 10 | | 300 | | 300 | μA |
| | switches ON or all switches OFF) | | | | 15 | | 0.04 | 20 | | 600 | | 600 | μΑ |
| | ownorios or r j | | | | 20 | | 0.08 | 100 | | 3000 | | 3000 | |
| SWITCH | | | | | | | | | | | | | |
| R _{ON} | Resistance | 0 <u><</u> V ₁ <u><</u> | | | 5 | | 470 | 1050 | | 1200 | | 1200 | |
| | | V _{DD} | 0 | 0 | 10 | | 180 | 400 | | 520 | | 520 | Ω |
| | | . 00 | | | 15 | | 125 | 280 | | 360 | | 360 | |
| Δ_{ON} | Resistance Δ_{RON} | 0 <u><</u> V ₁ <u><</u> | | | 5 | | 10 | | | | | | |
| | (between any 2 of | V _{DD} | 0 | 0 | 10 | | 10 | | | | | | Ω |
| | 4 switches) | , DD | | | 15 | | 5 | | | | | | |
| OFF* | Channel Leakage Current (All Channel OFF) (COMMON O/I) | | 0 | 0 | 18 | | ±0.1 | 100 | | 1000 | | 1000 | nA |
| OFF* | Channel Leakage Current (Any Channel OFF) | | 0 | 0 | 18 | | ±0.1 | 100 | | 1000 | | 1000 | nA |
| C _I | Input Capacitance | | | | | | 5 | | | | | | |
| Co | Output Capacitance | | -5 | -5 | 5 | | 18 | | | | | | pF |
| C _{IO} | Feed through | | | | | | 0.2 | | | | | | |
| CONTRO | DL (Address or Inhi | bit) | | l | l | l | l | l | l | l | 1 | 1 | |
| V _{IL} | Input Low Voltage | | V _{EE} = | = Voo | 5 | | | 1.5 | | 1.5 | | 1.5 | |
| | | | | 1KΩ | 10 | | | 3 | | 3 | | 3 | V |
| | | = VDD | to \ | | 15 | | | 4 | | 4 | | 4 | |
| V _{IH} | Input High Voltage | thru 1KΩ | | 2μΑ | 5 | 3.5 | | | 3.5 | | 3.5 | | |
| | | | | I OFF | 10 | 7 | | | 7 | | 7 | | V |
| | | | chan | nels) | 15 | 11 | | | 11 | | 11 | | |
| I _{IH,} I _{IL} | Input Leakage Current | VI | = 0/18\ | / | 18 | | ±10 ⁻³ | ±0.1 | | ±1 | | ±1 | μΑ |
| C _I | Input Capacitance | | | | | | 5 | 7.5 | | | | | pF |

^{*} Determined by minimum feasible leakage measurement for automating testing.

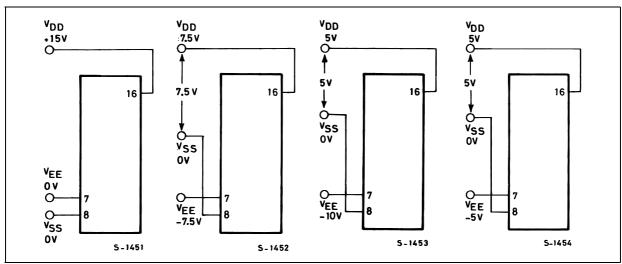
DYNAMIC ELECTRICAL CHARACTERISTICS ($T_{amb} = 25^{\circ}C$, $C_{L} = 50 pF$, all input square wave rise and fall time = 20 ns)

| | | | | Test Co | ndition | | | | Value | | Unit |
|---|------------------------|----------------------------|-------------------------|---------------------------|----------------------------|----------------------------|---|------|-------|------|------------|
| Parameter | V _{EE} (V) | R _L (ΚΩ) | f _I (KHz) | V _I (V) | V _{SS} (V) | V _{DD} (V) | | Min. | Тур. | Max. | |
| Propagation Delay | | | | V_{DD} | | 5 | | | 30 | 60 | |
| Time (signal input to | | 200 | | | | 10 | | | 15 | 30 | ns |
| output) | | | | | | 15 | | | 11 | 20 | |
| Frequency Response Channel "ON" (sine | = V _{SS} | 1 | | 5(*) | | 10 | V _O at Common OUT/IN | | 25 | | MHz |
| wave input) at $20 \log V_O/V_I = -3dB$ | - VSS | • | | 3() | | 10 | V _O at any channel | | 60 | | IVII IZ |
| Feed through (all channels OFF) at | = V _{SS} | 1 | | 5(*) | | 10 | V _O at Common OUT/IN | | 10 | | MHz |
| $20 \log V_O/V_I = -40 dB$ | . 22 | , | | 3() | | 10 | V _O at any channel | | 8 | | 1011 12 |
| Frequency Signal Crosstalk at | = V _{SS} | 1 | | 5(*) | | 10 | Between Sections (measured on common) | | 6 | | MHz |
| $20 \log V_{O}/V_{I} = -40 dB$ | - • \$\$ | ı | | 3() | | 10 | Between Sections (measured on any channel) | | 10 | | IVII IZ |
| Sine Wave Distortion | | | | 2(*) | | 5 | | | 0.3 | | |
| f _{IS} = 1KHz Sine Wave | $=V_{SS}$ | 10 | 1 | 3(*) | | 10 | | | 0.2 | | % |
| IIS - ITAIL ONIO WAVE | | | | 5(*) | | 15 | | | 0.12 | | |
| CONTROL (Address | or Inhibi | t) | | | | | • | | | | |
| Propagation Delay: | 0 | | | | 0 | 5 | | | 360 | 720 | |
| Address to Signal | 0 | | | | 0 | 10 | | | 160 | 320 | ns |
| OUT (Channels ON or OFF) | 0 | | | | 0 | 15 | | | 120 | 240 | 113 |
| 0. 0.17 | -5 | | | | 0 | 5 | | | 225 | 450 | |
| Propagation Delay: | 0 | | | | 0 | 5 | | | 360 | 720 | |
| Inhibit to Signal OUT | 0 | 1 | | | 0 | 10 | | | 160 | 320 | ns |
| (Channel turning ON) | 0 | ' | | | 0 | 15 | | | 120 | 240 | 113 |
| | -10 | | | | 0 | 5 | | | 200 | 400 | |
| Propagation Delay: | 0 | | | | | 5 | | | 200 | 450 | |
| Inhibit to Signal OUT | 0 | 10 | | | | 10 |] | | 90 | 210 | |
| (Channel turning OFF) | 0 | 10 | | | | 15 |] | | 70 | 160 | ns |
| | -10 | | | | | 5 | 1 | | 130 | 300 | |
| Address or Inhibit to Signal Crosstalk | 0 | 10 ⁽¹⁾ | | | 0 | 10 | $V_C = V_{DD} - V_{SS}$ (square wave) | | 65 | | mV peak |

⁽¹⁾ Both ends of channel.

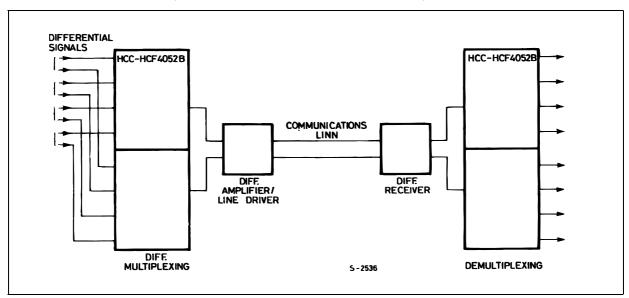
* Peak to Peak voltage symmetrical about (V_{DD} - V_{EE}) /2

TYPICAL BIAS VOLTAGES



The ADDRESS (digtal-control inputs) and INHIBIT logic levels are : "0"= V_{SS} and "1"= V_{DD} . The analog signal (through the TG) may swing from V_{EE} to V_{DD}

TYPICAL APPLICATIONS (TYPICAL TIME-DIVISION APPLICATION)

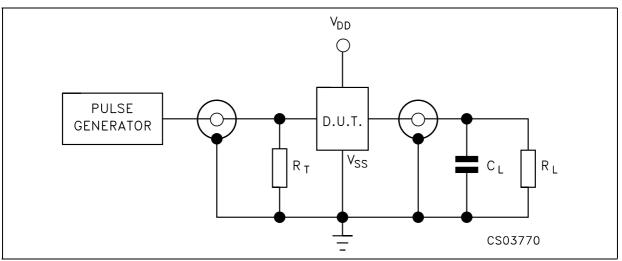


SPECIAL CONSIDERATIONS

Control of analog signals up to 20V peak to peak can be achieved by digital signal amplitudes of 4.5 to 20V (if V_{DD} - V_{SS} = 3V, a V_{DD} - V_{EE} of up to 13V can be controlled; for V_{DD} - V_{EE} level differences above 13V, a V_{DD} - V_{SS} of at least 4.5V is required. For example, if V_{DD} = +5, V_{SS} = 0, and V_{EE} = -13.5, analog signals from -13.5V to 4.5V can be controlled by digital inputs of 0 to 4.5V. In certain applications, the external load resistor

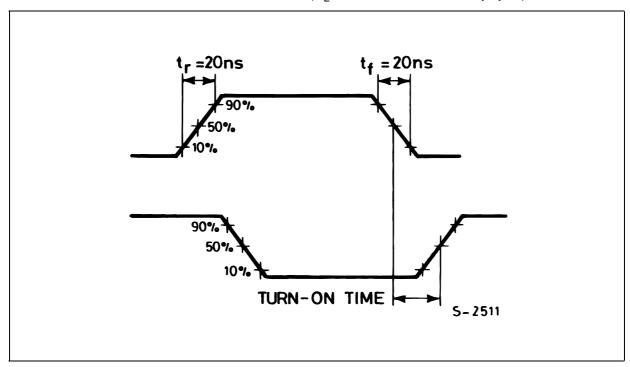
current may include both V_{DD} and signal-line components. To avoid drawing V_{DD} current when switch current flows into the transmission gate inputs, the voltage drop across the bidirectional switch must not exceed 0,8V (calculated from R_{ON} values shown in DC SPECIFICATIONS). No V_{DD} current will flow through R_{L} if the switch current flows into leads 3 and 13.

TEST CIRCUIT

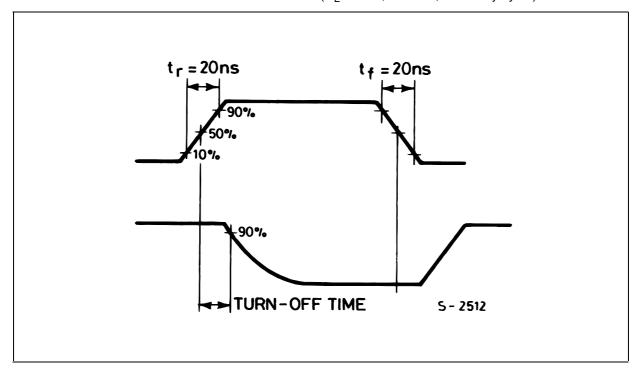


 C_L = 50pF or equivalent (includes jig and probe capacitance) R_L = 200KΩ R_T = Z_{OUT} of pulse generator (typically 50Ω)

WAVEFORM 1 : CHANNEL BEING TURNED ON ($R_L = 1 \text{K}\Omega$, f=1MHz; 50% duty cycle)

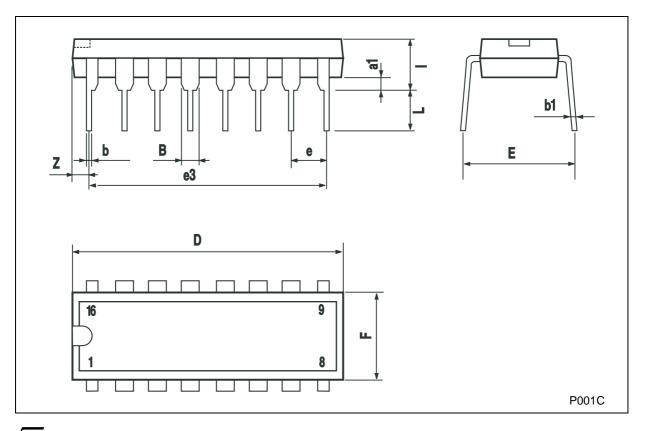


WAVEFORM 2 : CHANNEL BEING TURNED OFF (R_L = 1K Ω , f=1MHz; 50% duty cycle)



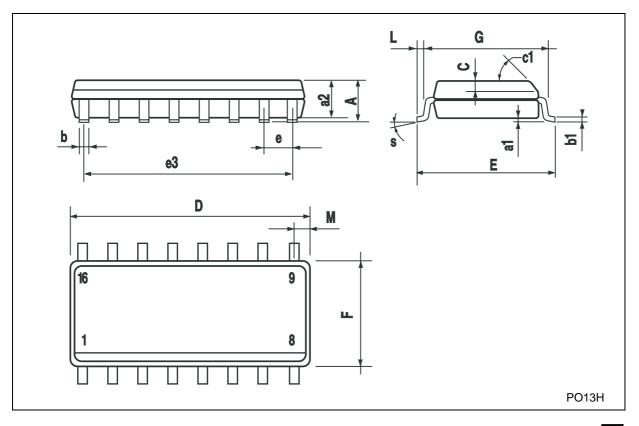
Plastic DIP-16 (0.25) MECHANICAL DATA

| DIM | | mm. | | inch | | | | |
|------|------|-------|------|-------|-------|-------|--|--|
| DIM. | MIN. | TYP | MAX. | MIN. | TYP. | MAX. | | |
| a1 | 0.51 | | | 0.020 | | | | |
| В | 0.77 | | 1.65 | 0.030 | | 0.065 | | |
| b | | 0.5 | | | 0.020 | | | |
| b1 | | 0.25 | | | 0.010 | | | |
| D | | | 20 | | | 0.787 | | |
| E | | 8.5 | | | 0.335 | | | |
| е | | 2.54 | | | 0.100 | | | |
| e3 | | 17.78 | | | 0.700 | | | |
| F | | | 7.1 | | | 0.280 | | |
| I | | | 5.1 | | | 0.201 | | |
| L | | 3.3 | | | 0.130 | | | |
| Z | | | 1.27 | | | 0.050 | | |



SO-16 MECHANICAL DATA

| DIM. | | mm. | | inch | | | | |
|--------|------|------|-------|--------|-------|-------|--|--|
| DIIVI. | MIN. | TYP | MAX. | MIN. | TYP. | MAX. | | |
| А | | | 1.75 | | | 0.068 | | |
| a1 | 0.1 | | 0.2 | 0.003 | | 0.007 | | |
| a2 | | | 1.65 | | | 0.064 | | |
| b | 0.35 | | 0.46 | 0.013 | | 0.018 | | |
| b1 | 0.19 | | 0.25 | 0.007 | | 0.010 | | |
| С | | 0.5 | | | 0.019 | | | |
| c1 | | | 45° | (typ.) | | | | |
| D | 9.8 | | 10 | 0.385 | | 0.393 | | |
| Е | 5.8 | | 6.2 | 0.228 | | 0.244 | | |
| е | | 1.27 | | | 0.050 | | | |
| e3 | | 8.89 | | | 0.350 | | | |
| F | 3.8 | | 4.0 | 0.149 | | 0.157 | | |
| G | 4.6 | | 5.3 | 0.181 | | 0.208 | | |
| L | 0.5 | | 1.27 | 0.019 | | 0.050 | | |
| М | | | 0.62 | | | 0.024 | | |
| S | | | 8° (ı | max.) | | • | | |



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